INTEGRATED CIRCUITS



Product specification Supersedes data of 1997 Feb 12 IC24 Data Handbook

1998 Apr 28



Philips Semiconductors

74LV153

FEATURES

- Optimized for low voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between V_{CC} = 2.7 V and V_{CC} = 3.6 V
- Typical V_{OLP} (output ground bounce) < 0.8 V at V_{CC} = 3.3 V, $T_{amb} = 25^{\circ}C$
- Typical V_{OHV} (output V_{OH} undershoot) > 2 V at V_{CC} = 3.3 V, $T_{amb} = 25^{\circ}C$
- Non-inverting outputs
- Separate enable for each output
- Common select inputs
- Permits multiplexing from n lines to 1 line
- Enable line provided for cascading (n lines to 1 line)
- Output capability: standard
- I_{CC} category: MSI

DESCRIPTION

The 74LV153 is a low-voltage CMOS device that is pin and function compatible with 74HC/HCT153.

The 74LV153 is a dual 4-input multiplexer which selects 2 bits of data from up to four sources selected by common data select inputs (S₀, S₁). The two 4-input multiplexer circuits have individual active LOW output enable inputs $(1\overline{E}, 2\overline{E})$ which can be used to strobe the outputs independently. The outputs (1Y, 2Y) are forced LOW when the corresponding output enable inputs are HIGH. The 74LV153 is the logic implementation of a 2-pole, 4-position switch, where the position of the switch, is determined by the logic levels applied to S₀ and S₁. The logic equations for the outputs are: $1Y=1\overline{E}.(1I_0.\overline{S}_1.\overline{S}_0+1I_1.\overline{S}_1.S_0+1I_2.S_1.\overline{S}_0+1I_3.S_1.S_0)$ $2Y=2\overline{E}.(2l_0.\overline{S}_1.\overline{S}_0+2l_1.\overline{S}_1.S_0+2l_2.S_1.\overline{S}_0+2l_3.S_1.S_0)$

The 74LV153 can be used to move data to a common output bus from a group of registers. The state of the select inputs would determine the particular register from which the data came. An alternative application is a function generator. The device can generate two functions or three variables. This is useful for implementing highly irregular random logic.

QUICK REFERENCE DATA

GND = 0 V: $T_{amb} = 25^{\circ}C$: $t_r = t_f \le 2.5$ ns

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t _{PHL} /t _{PLH}	Propagation delay 1I _n , 2I _n to nY Sn to nY nE to nY	C _L = 15 pF; V _{CC} = 3.3 V	14 14 10	ns
Cl	Input capacitance		3.5	pF
C _{PD}	Power dissipation capacitance per gate	$V_I = GND$ to V_{CC}^1	30	pF

NOTE

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μ W)

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

 $f_i = \text{input frequency in MHz; } C_L = \text{output load capacitance in pF; } \\ f_o = \text{output frequency in MHz; } V_{CC} = \text{supply voltage in V; }$

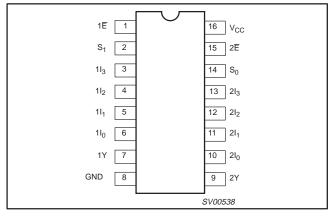
 $\sum (C_L \times V_{CC}^2 \times f_0) =$ sum of the outputs.

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
16-Pin Plastic DIL	–40°C to +125°C	74LV153 N	74LV153 N	SOT38-4
16-Pin Plastic SO	–40°C to +125°C	74LV153 D	74LV153 D	SOT109-1
16-Pin Plastic SSOP Type II	–40°C to +125°C	74LV153 DB	74LV153 DB	SOT338-1
16-Pin Plastic TSSOP Type I	–40°C to +125°C	74LV153 PW	74LV153PW DH	SOT403-1

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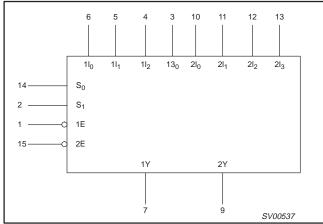
PIN CONFIGURATION



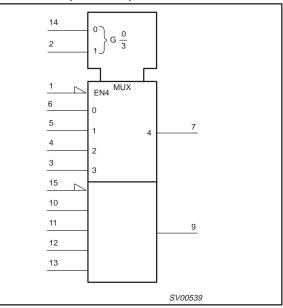
PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1, 15	1Ē, 2Ē	Output enable inputs (active LOW)
14, 2	S ₀ , S ₁	Common data select inputs
6, 5, 4, 3	11 ₀ to 11 ₃	Data inputs from source 1
7	1Y	Multiplexer output from source 1
8	GND	Ground (0 V)
9	2Y	Multiplexer output from source 2
10, 11, 12, 13	$2l_0$ to $2l_3$	Data inputs from source 2
16	V _{CC}	Positive supply voltage

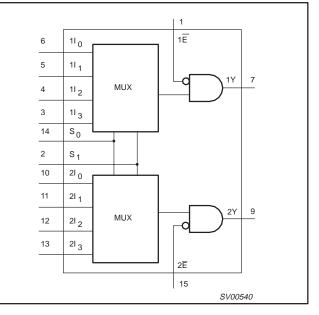
LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)

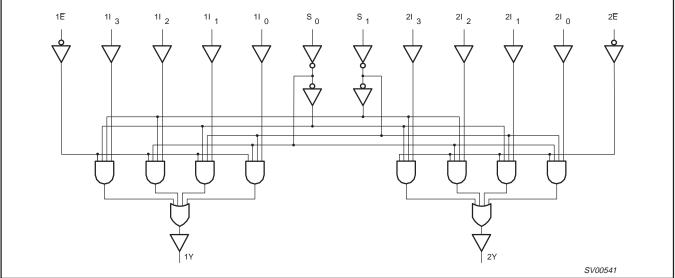


FUNCTIONAL DIAGRAM



74LV153

LOGIC DIAGRAM



FUNCTION TABLE

SELECT			DATA I		OUTPUT ENABLE	OUTPUT	
S ₀	S ₁	nl ₀	nl ₁	nl ₂	nl ₃	nE	nY
Х	Х	Х	Х	Х	Х	Н	L
L	L	L	Х	Х	Х	L	L
L	L	Н	х	х	х	L	Н
н	L	х	L	х	х	L	L
н	L	х	н	х	х	L	н
L	н	Х	Х	L	Х	L	L
L	н	х	х	н	х	L	Н
н	н	х	х	х	L	L	L
н	н	х	х	х	Н	L	Н

NOTES: H = HIGH voltage level L = LOW voltage level X = don't care

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
V _{CC}	DC supply voltage	See Note 1	1.0	3.3	3.6	V
VI	Input voltage		0	-	V _{CC}	V
Vo	Output voltage		0	-	V _{CC}	V
T _{amb}	Operating ambient temperature range in free air	See DC and AC characteristics	-40 -40		+85 +125	°C
t _r , t _f	Input rise and fall times	$V_{CC} = 1.0V \text{ to } 2.0V$ $V_{CC} = 2.0V \text{ to } 2.7V$ $V_{CC} = 2.7V \text{ to } 3.6V$	- - -	- - -	500 200 100	ns/V

NOTE:

1. The LV is guaranteed to function down to V_{CC} = 1.0V (input levels GND or V_{CC}); DC characteristics are guaranteed from V_{CC} = 1.2V to V_{CC} = 3.6V.

ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +4.6	V
$\pm I_{IK}$	DC input diode current	$V_{\rm I} < -0.5 \text{ or } V_{\rm I} > V_{\rm CC} + 0.5 \text{V}$	20	mA
± I _{OK}	DC output diode current	$V_{O} < -0.5$ or $V_{O} > V_{CC} + 0.5V$	50	mA
$\pm I_{O}$	DC output source or sink current – standard outputs	$-0.5V < V_O < V_{CC} + 0.5V$	25	mA
±I _{GND} , ±I _{CC}	DC V _{CC} or GND current for types with – standard outputs		50	mA
T _{stg}	Storage temperature range		–65 to +150	°C
P _{TOT}	Power dissipation per package – plastic DIL – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	-4	0°C to +8	5°C	-40°C to	o +125°C	UNIT
			MIN	TYP ¹	MAX	MIN	MAX	VNIT V V V
		V _{CC} = 1.2 V	0.9			0.9		
V _{IH}	HIGH level Input voltage	$V_{CC} = 2.0 V$	1.4			1.4		V
		$V_{CC} = 2.7$ to 3.6 V	2.0			2.0		
		V _{CC} = 1.2 V			0.3		0.3	
VIL	LOW level Input voltage	$V_{CC} = 2.0 V$			0.6		0.6	V
	, enage	$V_{CC} = 2.7 \text{ to } 3.6 \text{ V}$			0.8		0.8	1
		V_{CC} = 1.2 V; V_I = V_{IH} or $V_{IL;}$ – I_O = 100 μ A		1.2				
	HIGH level output	V_{CC} = 2.0 V; V _I = V _{IH} or V _{IL} ; $-I_O$ = 100 μ A	1.8	2.0		1.8		
V _{OH}	voltage; all outputs	V_{CC} = 2.7 V; V_I = V_{IH} or V_{IL} ; $-I_O$ = 100 μ A	2.5	2.7		2.5		1 [×]
		$V_{CC} = 3.0 \text{ V}; \text{ V}_{I} = V_{IH} \text{ or } \text{V}_{IL;} - \text{I}_{O} = 100 \mu \text{A}$	2.8	3.0		2.8		1
V _{OH}	HIGH level output voltage; STANDARD outputs	$V_{CC} = 3.0 \text{ V}; \text{ V}_{I} = \text{V}_{IH} \text{ or } \text{V}_{IL}; -\text{I}_{O} = 6\text{mA}$	2.40	2.82		2.20		V
		V_{CC} = 1.2 V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A		0				
No.	LOW level output	V_{CC} = 2.0 V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A		0	0.2		0.2	
V _{OL}	voltage; all outputs	V_{CC} = 2.7 V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A		0	0.2		0.2	Ň
		V_{CC} = 3.0 V; V_{I} = V_{IH} or $V_{IL;}$ I_{O} = 100 μA		0	0.2		0.2	
V _{OL}	LOW level output voltage; STANDARD outputs	V_{CC} = 3.0 V; V_{I} = V_{IH} or V_{IL} ; I_{O} = 6mA		0.25	0.40		0.50	V
I	Input leakage current	V_{CC} = 3.6 V; V_{I} = V_{CC} or GND			1.0		1.0	μΑ
Icc	Quiescent supply current; MSI	V_{CC} = 3.6 V; V_{I} = V_{CC} or GND; I_{O} = 0			20.0		160	μA
ΔI _{CC}	Additional quiescent supply current per input	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}; \text{ V}_{I} = \text{V}_{CC} - 0.6 \text{ V}$			500		850	μΑ

NOTE:

1. All typical values are measured at $T_{amb} = 25^{\circ}C$.

Product specification

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AC CHARACTERISTICS

GND = 0V; $t_r = t_f = 2.5 \text{ns}$; $C_L = 50 \text{pF}$; $R_L = K\Omega$

			CONDITION			LIMITS			
SYMBOL	PARAMETER	WAVEFORM	CONDITION	-40 to +85 °C -40 to				+125 °C	UNIT
			V _{CC} (V)	MIN	TYP ¹	MAX	MIN	MAX	
		1.2		85					
t	Propagation delay	Figures 1, 2	2.0		29	56		66	00
t _{PHL} /t _{PLH} 1I _n to nY; 2I _n to nY	Figures 1, 2	2.7		21	41		49	ns	
		3.0 to 3.6		16 ²	33		39		
			1.2		90				
t	Propagation delay	Figures 1, 2	2.0		31	58		70	20
t _{PHL} /t _{PLH}	S _n to nY	Figures 1, 2	2.7		23	43		51	115
			3.0 to 3.6		17 ²	34		41	
			1.2		60				
tt	Propagation delay	Figuros 1-2	2.0		20	39		46	UNIT ns ns
t _{PHL} /t _{PLH}	nE to nY	Figures 1, 2	2.7		15	29		34	
		3.0 to 3.6		11 ²	23		27		

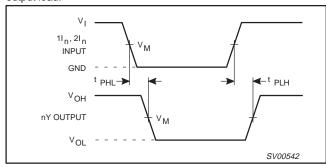
NOTES:

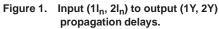
1. Unless otherwise stated, all typical values are measured at $T_{amb} = 25^{\circ}C$

2. Typical values are measured at V_{CC} = 3.3 V.

AC WAVEFORMS

 V_M = 1.5 V at V_{CC} \geq 2.7 V; V_M = 0.5 V \times V_{CC} at V_{CC} <2.7 V; V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.





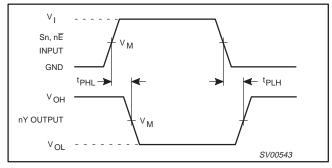


Figure 2. Select input (S_0, S_1) and the output enable input (\overline{E}) to output $(n\overline{Y}_n)$ propagation delays.

TEST CIRCUIT

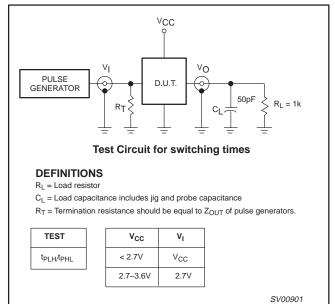
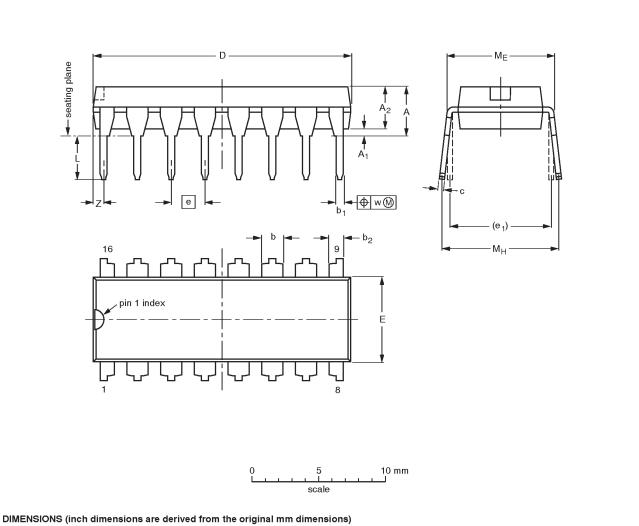


Figure 3. Load circuitry for switching times.

DIP16: plastic dual in-line package; 16 leads (300 mil)



UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	c	D ⁽¹⁾	Е ⁽¹⁾	e	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

Note

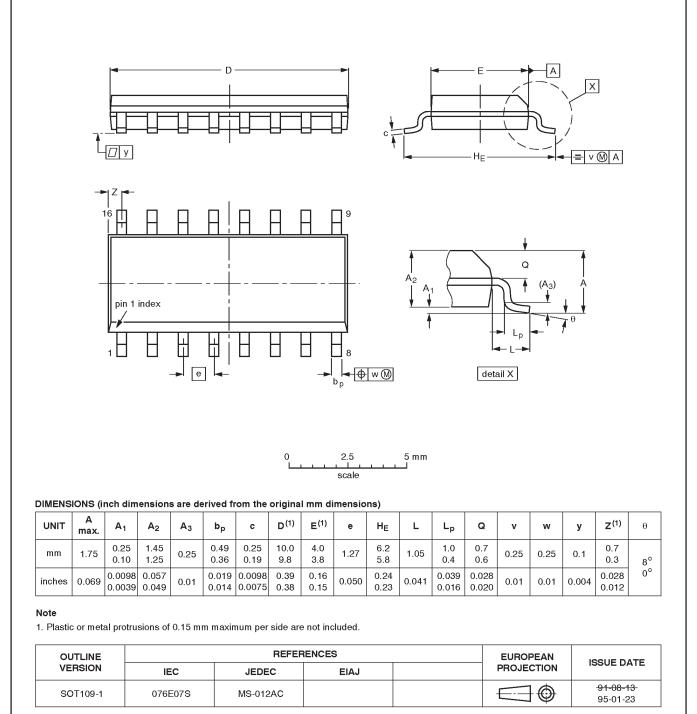
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	
SOT38-4						-92-11-17 95-01-14

Product specification

SOT38-4

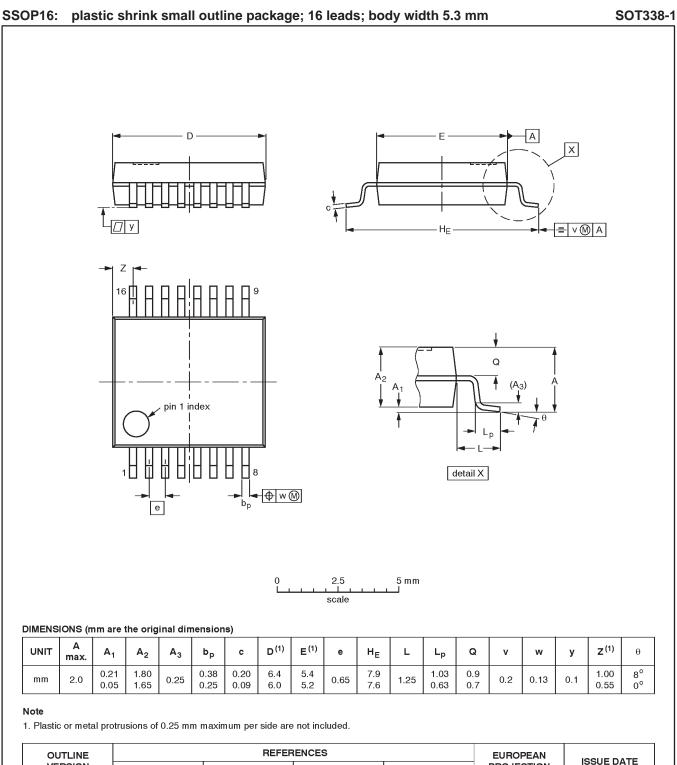
SO16: plastic small outline package; 16 leads; body width 3.9 mm



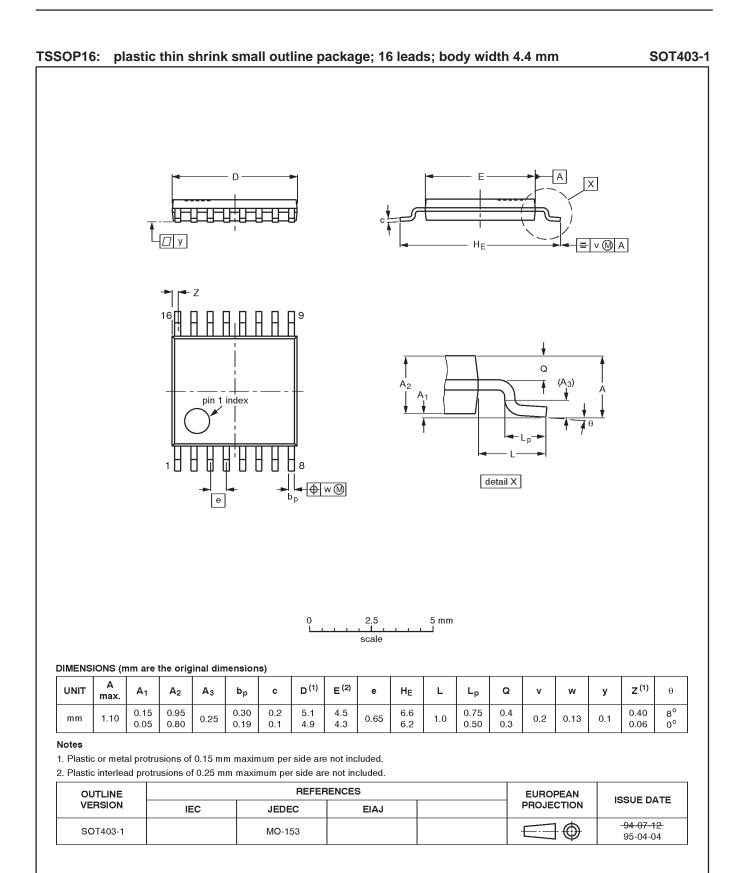
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	DEFINITIONS						
Data Sheet Identification Product Status Definition							
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